

HFA08TB60

HEXFRED™

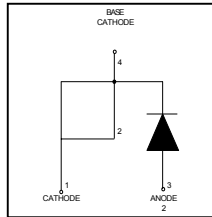
Ultrafast, Soft Recovery Diode

Features

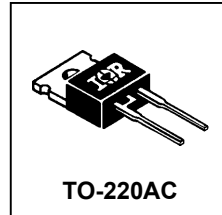
- Ultrafast Recovery
- Ultrasoft Recovery
- Very Low I_{RRM}
- Very Low Q_{rr}
- Specified at Operating Conditions

Benefits

- Reduced RFI and EMI
- Reduced Power Loss in Diode and Switching Transistor
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count



$V_R = 600V$
$V_F(\text{typ.})^* = 1.4V$
$I_{F(AV)} = 8.0A$
$Q_{rr}(\text{typ.}) = 65nC$
$I_{RRM} = 5.0A$
$t_r(\text{typ.}) = 18ns$
$di_{(rec)}/dt(\text{typ.}) = 240A/\mu s$



Description

International Rectifier's HFA08TB60 is a state of the art ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 volts and 8 amps continuous current, the HFA08TB60 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA08TB60 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

Absolute Maximum Ratings

	Parameter	Max	Units
V_R	Cathode-to-Anode Voltage	600	V
$I_F @ T_C = 100^\circ C$	Continuous Forward Current	8.0	A
I_{FSM}	Single Pulse Forward Current	60	
I_{FRM}	Maximum Repetitive Forward Current	24	W
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	36	
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	14	C
T_J	Operating Junction and	- 55 to +150	
T_{STG}	Storage Temperature Range		

* 125°C

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min	Typ	Max	Units	Test Conditions
V _{BR}	Cathode Anode Breakdown Voltage	600			V	I _R = 100μA
V _{FM}	Max Forward Voltage		1.4	1.7	V	I _F = 8.0A
			1.7	2.1		I _F = 16A See Fig. 1
			1.4	1.7		I _F = 8.0A, T _J = 125°C
I _{RM}	Max Reverse Leakage Current		0.3	5.0	μA	V _R = V _R Rated See Fig. 2
			100	500		T _J = 125°C, V _R = 0.8 x V _R Rated
C _T	Junction Capacitance		10	25	pF	V _R = 200V See Fig. 3
L _S	Series Inductance		8.0		nH	Measured lead to lead 5mm from package body

Dynamic Recovery Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min	Typ	Max	Units	Test Conditions	
t _{rr}	Reverse Recovery Time		18		ns	I _F = 1.0A, di _F /dt = 200A/μs, V _R = 30V	
t _{rr1}	See Fig. 5, 6 & 16		37	55		T _J = 25°C	
t _{rr2}			55	90		T _J = 125°C	
I _R RM1	Peak Recovery Current		3.5	5.0	A	I _F = 8.0A V _R = 200V	
I _R RM2	See Fig. 7 & 8		4.5	8.0			T _J = 125°C
Q _{rr1}	Reverse Recovery Charge		65	138	nC	di _F /dt = 200A/μs	
Q _{rr2}	See Fig. 9 & 10		124	360			T _J = 25°C
dI _{(rec)M} /dt1	Peak Rate of Fall of Recovery Current		240				T _J = 25°C
dI _{(rec)M} /dt2	During t _b See Fig. 11 & 12		210		A/μs	T _J = 125°C	

Thermal - Mechanical Characteristics

	Parameter	Min	Typ	Max	Units
T _{lead} ①	Lead Temperature			300	°C
R _{thJC}	Thermal Resistance, Junction to Case			3.5	K/W
R _{thJA} ②	Thermal Resistance, Junction to Ambient			80	
R _{thCS} ③	Thermal Resistance, Case to Heat Sink		0.5		
Wt	Weight		2.0		g
			0.07		(oz)
	Mounting Torque		6.0	12	Kg-cm
			5.0	10	lbf-in

① 0.063 in. from Case (1.6mm) for 10 sec

② Typical Socket Mount

③ Mounting Surface, Flat, Smooth and Greased

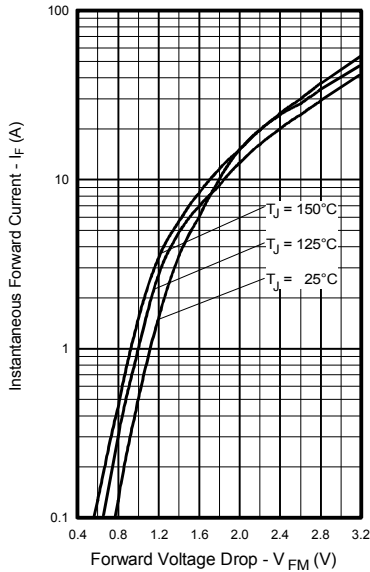


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

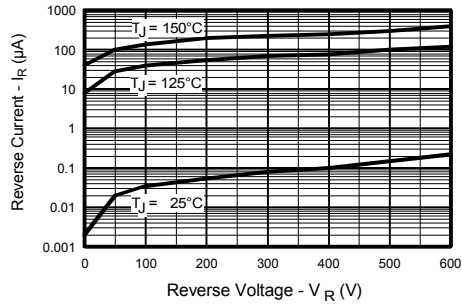


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

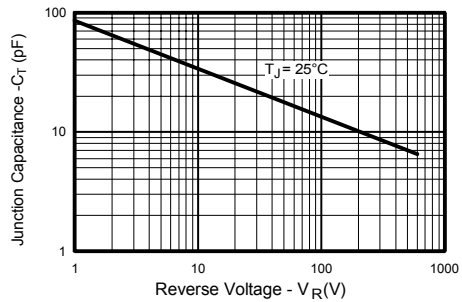


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

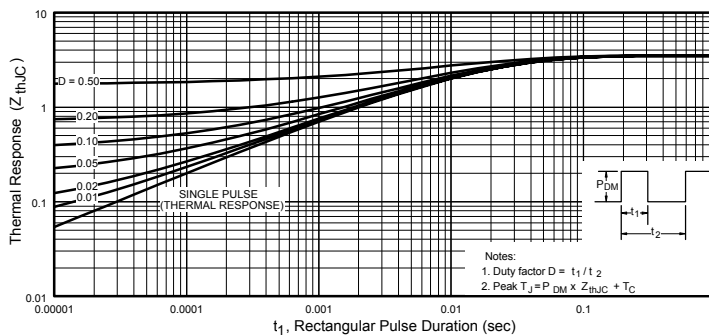


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

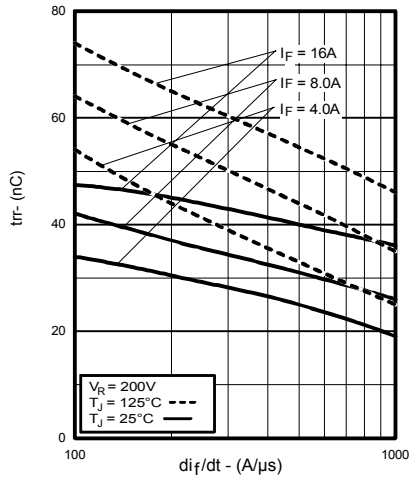


Fig. 5 - Typical Reverse Recovery vs. di_f/dt

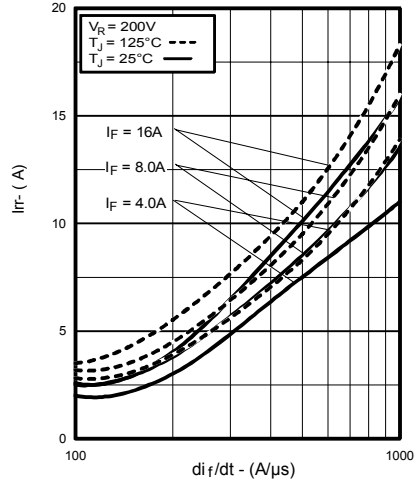


Fig. 6 - Typical Recovery Current vs. di_f/dt

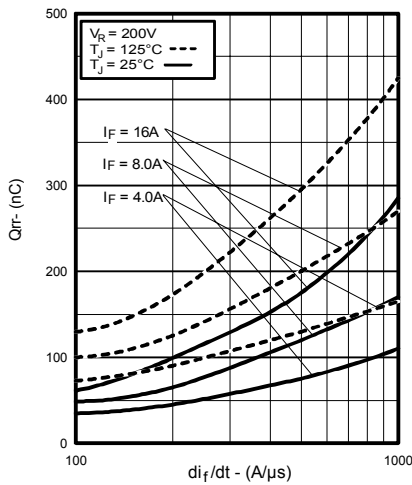


Fig. 7 - Typical Stored Charge vs. di_f/dt

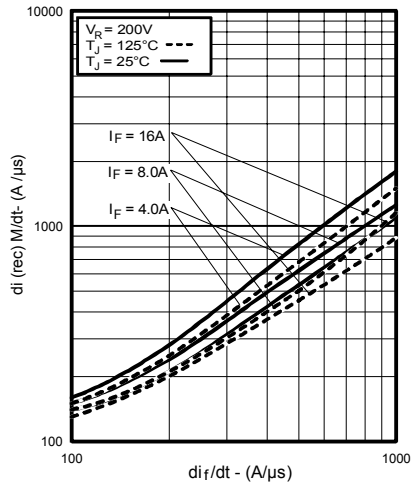


Fig. 8 - Typical $di_{(rec)M}/dt$ vs. di_f/dt

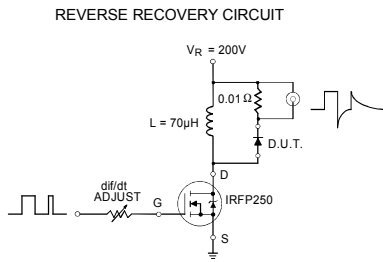


Fig. 9 - Reverse Recovery Parameter Test Circuit

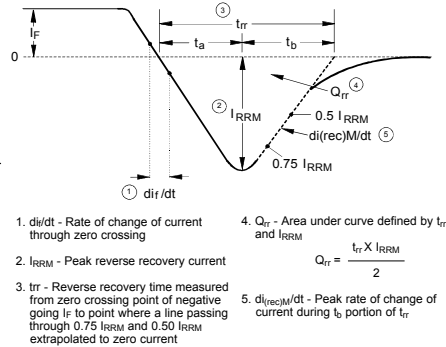
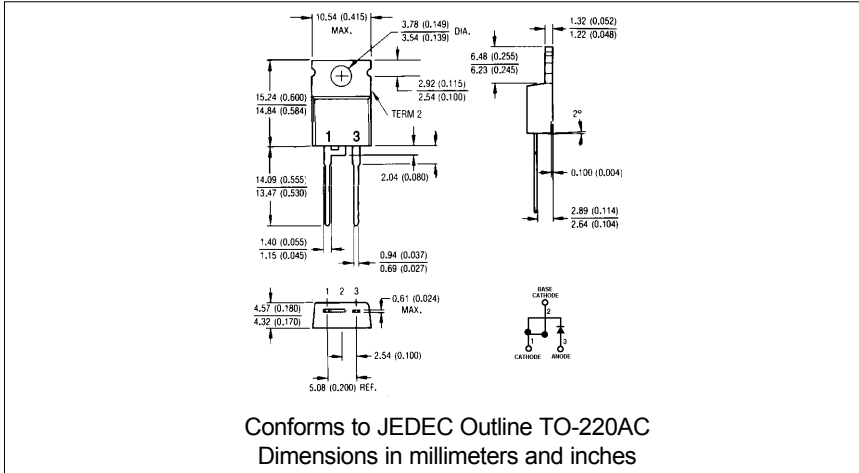


Fig. 10 - Reverse Recovery Waveform and Definitions

HFA08TB60

Bulletin PD-2.341 rev. A 10/00

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WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245 U.S.A. Tel: (310) 322 3331. Fax: (310) 322 3332.
EUROPEAN HEADQUARTERS: Hurst Green, Oxted, Surrey RH8 9BB, U.K. Tel: +44 1883 732020. Fax: +44 1883 733408.
IR CANADA: 15 Lincoln Court, Brampton, Markham, Ontario L6T3Z2. Tel: (905) 453 2200. Fax: (905) 475 8801.
IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg. Tel: +49 6172 96590. Fax: +49 6172 965933.
IR ITALY: Via Liguria 49, 10071 Borgaro, Torino. Tel: +39 11 4510111. Fax: +39 11 4510220.
IR FAR EAST: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo, Japan 171. Tel: 81 3 3983 0086.
IR SOUTHEAST ASIA: 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994. Tel: +65 838 4630.
IR TAIWAN: 16 Fl. Suite D.207, Sec. 2, Tun Haw South Road, Taipei, 10673, Taiwan. Tel: 886 2 2377 9936.

<http://www.irf.com>

Fax-On-Demand: +44 1883 733420

Data and specifications subject to change without notice.